

## PATENT ASSIGNMENT

Electronic Version v1.1  
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SUBMISSION TYPE:	NEW ASSIGNMENT																		
NATURE OF CONVEYANCE:	ASSIGNMENT																		
CONVEYING PARTY DATA																			
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Douglas S. Selph</td> <td>01/13/2011</td> </tr> <tr> <td>Mark Dyer</td> <td>01/27/2011</td> </tr> <tr> <td>Enrique J. Wong</td> <td>01/14/2011</td> </tr> <tr> <td>Kenneth F. Wolfinger</td> <td>01/14/2011</td> </tr> <tr> <td>Charles M. Kellerhals</td> <td>01/14/2011</td> </tr> <tr> <td>Bradley T. Kranz</td> <td>01/11/2011</td> </tr> <tr> <td>Daniel P. Quigley</td> <td>01/26/2011</td> </tr> <tr> <td>John T. Braun</td> <td>01/19/2011</td> </tr> </tbody> </table>		Name	Execution Date	Douglas S. Selph	01/13/2011	Mark Dyer	01/27/2011	Enrique J. Wong	01/14/2011	Kenneth F. Wolfinger	01/14/2011	Charles M. Kellerhals	01/14/2011	Bradley T. Kranz	01/11/2011	Daniel P. Quigley	01/26/2011	John T. Braun	01/19/2011
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<table border="1"> <tr> <td>Name:</td> <td>TIP Solutions, Inc.</td> </tr> <tr> <td>Street Address:</td> <td>113 McHenry Road</td> </tr> <tr> <td>Internal Address:</td> <td>PMB 117</td> </tr> <tr> <td>City:</td> <td>Buffalo Grove</td> </tr> <tr> <td>State/Country:</td> <td>ILLINOIS</td> </tr> <tr> <td>Postal Code:</td> <td>60089</td> </tr> </table>		Name:	TIP Solutions, Inc.	Street Address:	113 McHenry Road	Internal Address:	PMB 117	City:	Buffalo Grove	State/Country:	ILLINOIS	Postal Code:	60089						
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CORRESPONDENCE DATA																			
Fax Number:	3123468434																		
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>																			
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Email:	IPDOCKET@LPLEGAL.COM																		
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CH \$40.00 13733575

Address Line 4: Chicago, ILLINOIS 60602

ATTORNEY DOCKET NUMBER:

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NAME OF SUBMITTER:

Mitchell J. Weinstein

Total Attachments: 9

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U.S. Serial No. 12/947,666

Filed: November 16, 2010

ASSIGNMENT

WHEREAS, we, Douglas S. Selph, residing at 1555 W. Pratt Blvd #1, Chicago, IL 60626, US; Mark Dyer, residing at 70 Meadowide, Tilehurst, Reading, Berkshire, RG31 5QE, UK; Enrique J. Wong, residing at 6124 Elmbridge Drive, San Jose, CA 95129, US; Kenneth F. Wolfinger, residing at 3850 White Cloud Dr., Skokie, Illinois 60076, US; Charles M. Kellerhals, residing at 524 Sierra Place, Gurnee, Illinois 60031, US; Bradley T. Kranz, residing at 28 Westover Road, Slingerlands, NY 12159, US; Daniel P. Quigley, residing at 19833 NE 123<sup>rd</sup> Court, Woodinville, WA 98077-5623, US; and John T. Braun, residing at 1195 Georgetown Way, Vernon Hills, IL 60061, US have invented new and useful improvements in COMMUNICATION MANAGEMENT FEATURE, and have filed a United States patent application therefor, the application serial number and filing date for which is noted above, and

WHEREAS, **TIP Solutions, Inc.**, an Illinois limited liability company, having a place of business at 113 McHenry Road, PMB 117 Buffalo Grove, IL 60089, US (hereinafter **Assignee**), is desirous of acquiring the entire right, title, and interest in and to said invention, said application, and in to and under all Letters Patent of the United States and foreign countries that may be granted therefor;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that for and in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration to me in hand and paid by said **TIP Solutions, Inc.** the receipt of which is hereby acknowledged, we, Douglas S. Selph, Mark Dyer, Enrique J. Wong, Kenneth F. Wolfinger, Charles M. Kellerhals, Bradley T. Kranz, Daniel P. Quigley, and John T. Braun, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over to and unto said **TIP Solutions, Inc.**, its successors and assigns, for, within and throughout the United States and the territories thereof, and all foreign countries, the entire right, title and interest in and to said invention, and in, to and under said application, and all Letters Patent of the United States and foreign countries that may be granted for said invention and improvements, including regular utility patent applications, divisions, reissues, subdivisions, continuations and

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prolongations of such applications and Letters Patent, to have and to hold for the sole and exclusive use and benefit of said **TIP Solutions, Inc.** its successors and assigns, to the full end of the term or terms for which any and all of said Letters Patent for said invention may issue, and further, including the right to **TIP Solutions, Inc.** to file in its name applications for Letters Patent to said improvements in any country or countries foreign to the United States including the full right to claim for any such applications the priority benefits of the International Convention for the Protection of Industrial Property and other priority conferring treaties, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof.

We do hereby covenant and agree, for ourselves, heirs and legal representatives, that we will assist said **TIP Solutions, Inc.** in the prosecution of the application herein identified; in the making and prosecution of any other applications for Letters Patent that said **TIP Solutions, Inc.** may elect to make covering the invention herein identified, as hereinbefore set forth; in vesting in said **TIP Solutions, Inc.**, like exclusive title in and to all such other applications and Letters Patent; and in the prosecution of any interference which may arise involving said invention, or any application or Letters Patent herein contemplated; and that we will execute and deliver to said **TIP Solutions, Inc.**, any and all additional papers that may be requested by said **TIP Solutions, Inc.**, to fully carry out the terms of this assignment.

And we do hereby authorize and request the Commissioner of Patents to issue all Letters Patent of the United States that may be granted pursuant to application aforesaid, or for said invention, to said **TIP Solutions, Inc.**, its successors and assigns in accordance with this assignment.

And we hereby covenant that we have full right to convey the entire interest herein assigned, and that we have not executed and will not execute any agreement in conflict herewith.

1/13/2011  
Date

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Date

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Date

  
DOUGLAS S. SELRIN

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MARK DYER

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ENRIQUE J. WONG

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27-JAN-2011

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Date

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Date

1/14/11

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Date

\_\_\_\_\_  
MARK DYER

\_\_\_\_\_  
ENRIQUE L. WONG

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Kenneth F. Wolfinger  
KENNETH F. WOLFINGER

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CHARLES M. KELLERHALS

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DANIEL P. QUIGLEY

Date

JOHN T. BRAUN

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Date

KENNETH F. WOLFINGER

1-14-11

Date

*Charles M. Kellerhals*  
CHARLES M. KELLERHALS

Date

BRADLEY T. KRANZ

Date

DANIEL P. QUIGLEY

Date

JOHN T. BRAUN



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KENNETH F. WOLFINGER

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**Date**

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CHARLES M. KELLERHALS

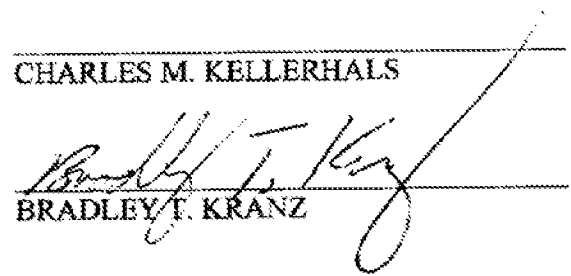
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**Date**

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BRADLEY T. KRANZ

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Date

CHARLES M. KELLERHALS

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BRADLEY L. KRANZ

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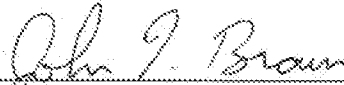
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BRADLEY T. KRANZ

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